

#### 3.2x1.6mm SMD CHIP LED LAMP

Part Number: KPTBD-3216SYKCGKC

Super Bright Yellow Green

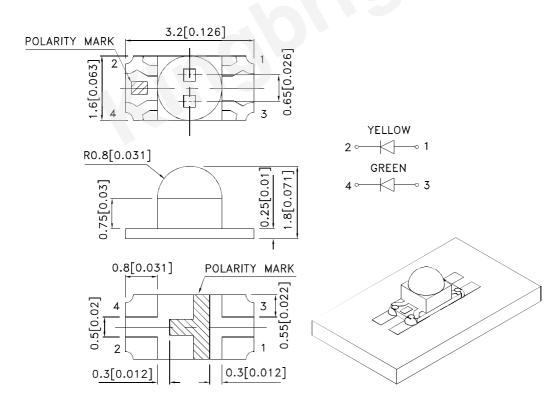
#### **Features**

- 3.2mmx1.6mm SMD LED,1.8mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### **Descriptions**

- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

#### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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#### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPTBD-3216SYKCGKC	Super Bright Yellow (AlGaInP)	Water Clear	300	600	30°
	Green (AlGalnP)	Water Clear	120	250	

- $1. \, \theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity / luminous Flux: +/-15%.
   Luminous intensity value is traceable to CIE127-2007 standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Yellow Green	590 574		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Yellow Green	590 570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Yellow Green	20 20		nm	IF=20mA
С	Capacitance	Super Bright Yellow Green	20 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Yellow Green	2 2.1	2.5 2.5	V	IF=20mA
lr	Reverse Current	Super Bright Yellow Green		10 10	uA	VR = 5V

#### Notes:

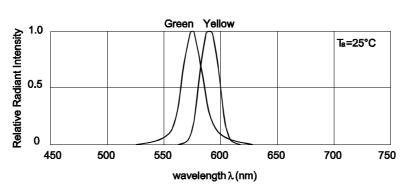
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Yellow	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	175	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

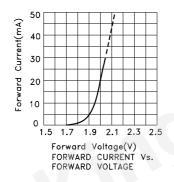
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

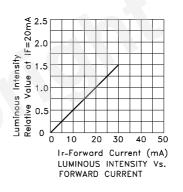
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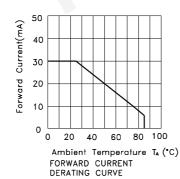


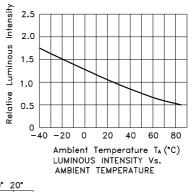
Relative Intensity Vs. Wavelength

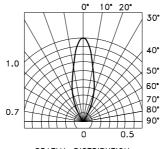
### KPTBD-3216SYKCGKC Super Bright Yellow







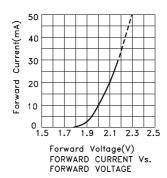


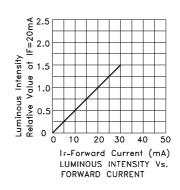


SPATIAL DISTRIBUTION

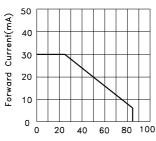
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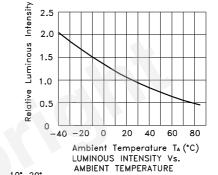
#### Green



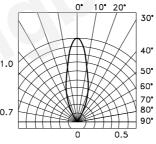


2.5









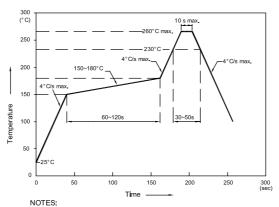
SPATIAL DISTRIBUTION

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#### KPTBD-3216SYKCGKC

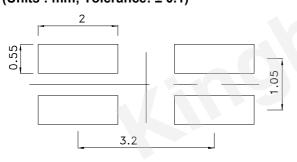
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



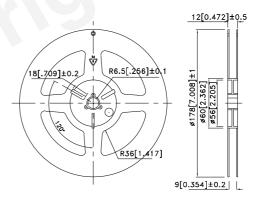
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
  3.Number of reflow process shall be 2 times or less.

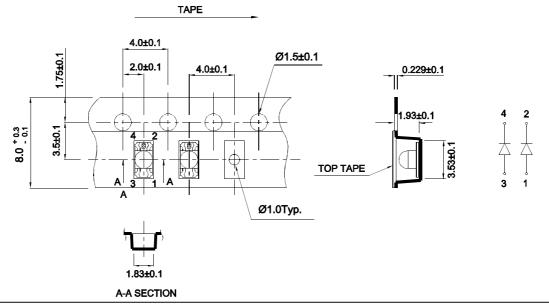
### Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### Tape Dimensions (Units: mm)

### **Reel Dimension**



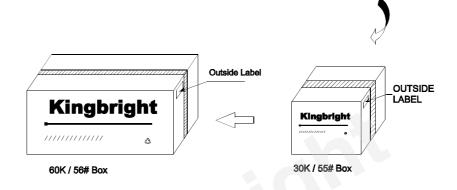


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# **PACKING & LABEL SPECIFICATIONS**

### User Direction OF Feed Label Labe 2000PCS / Reel 1 Reel / Bag

KPTBD-3216SYKCGKC





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